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- Three-State Version of SN54/74LS153, SN54/74S153
- Schottky-Diode-Clamped Transistors
- Permits Multiplexing from N Lines to 1 Line
- Performs Parallel-to Serial Conversion
- Fully Compatible with Most TTL Circuits
- Low Power Dissipation
 1 S253
 35 mW Typic

'LS253 . . . 35 mW Typical 'S253 . . . 225 mW Typical

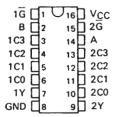
description

Each of these Schottky-clamped data selectors/multiplexers contains inverters and drivers to supply fully complementary, on-chip, binary decoding data selection to the AND-OR gates. Separate output control inputs are provided for each of the two four-line sections.

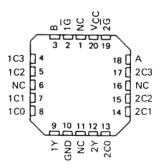
The three-state outputs can interface with and drive data lines of bus-organized systems. With all but one of the common outputs disabled (at a high-impedance state) the low-impedance of the single enabled output will drive the bus line to a high or low logic level.

SN54LS253, SN54S253 . . . J OR W PACKAGE SN74LS253, SN74S253 . . . D OR N PACKAGE

(TOP VIEW)



SN54LS253, SN54S253 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection

FUNCTION TABLE

| 1 | ECT UTS | | DATA | INPUTS | | OUTPUT CONTROL | ОUТРUТ |
|---|------------|----|------|--------|----|-------------------|--------|
| В | Α | CO | C1 | C2 | C3 | G | Υ |
| X | X | X | X | X | X | Н | Z |
| Ł | L | L | X | X | X | L | L |
| L | L | Н | X | X | X | L | н |
| L | Н | × | L | X | Х | L | L |
| L | Н | × | Н | X | X | L | н |
| Н | L | × | × | L | × | L | L |
| н | L | × | X | Н | X | L | Н |
| H | Н | × | X | X | L | L | L |
| Н | H | X | X | X | Н | L | Н |

Address inputs A and B are common to both sections.

H = high level, L = low level, X = irrelevant, Z = high impedance (off)

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

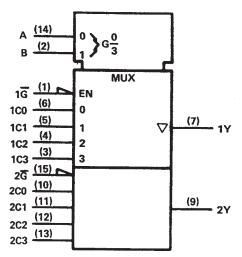
| Supply voltage, VCC (see Note 1) | 7 V |
|---|-------|
| Input voltage: 'LS253 | 7 V |
| '\$253 | 5.5 V |
| Off-state output voltage | |
| Operating free-air temperature range: SN54LS253, SN54S253 | 125°C |
| SN74LS253, SN74S253 0°C to | |
| Storage temperature range – 65°C to | 150°C |

NOTE 1: Voltage values are with respect to network ground terminal.

TEXAS INSTRUMENTS

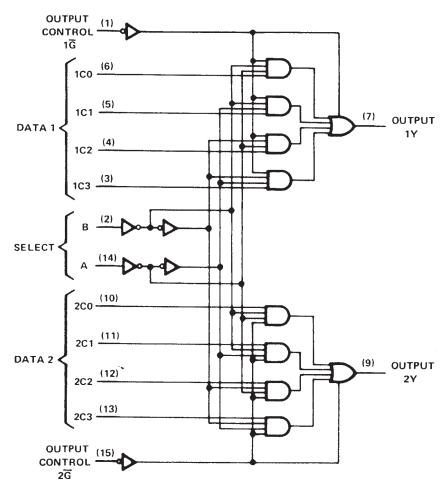
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logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

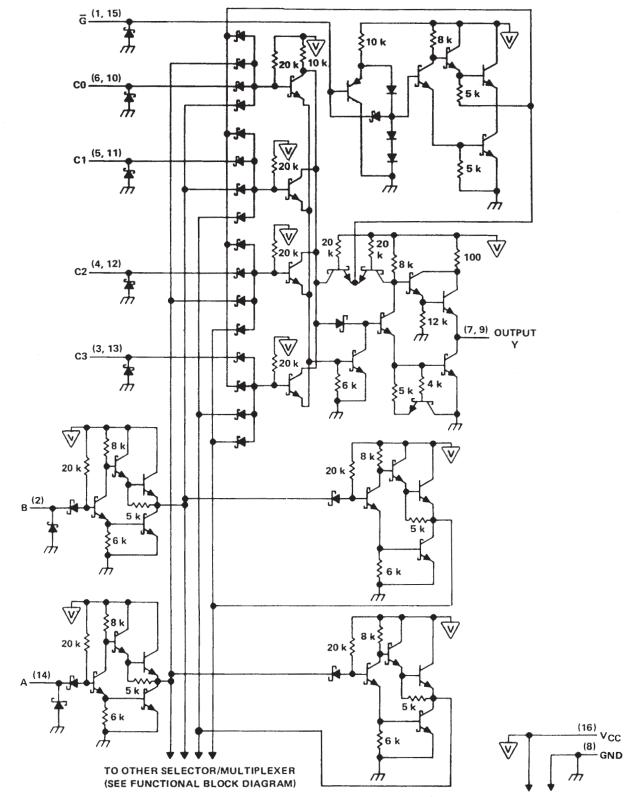
logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.



schematic (each selector/multiplexer, and the common select section)



Pin numbers shown are for D, J, N, and W packages.



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recommended operating conditions

| | | S | N54LS2 | 53 | SN74LS253 | | | UNIT |
|-----|--------------------------------|------|--------|-----|-----------|-----|-------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNII |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| VIL | Low-level input voltage | | | 0.7 | | | 0.8 | V |
| Іон | High-level output current | | | - 1 | | | - 2.6 | mA |
| IOL | Low-level output current | | | 4 | | | 8 | mA |
| TA | Operating free-air temperature | - 55 | | 125 | 0 | | 70 | °c |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITI | ONCT | | S | N54LS2 | 53 | S | LIBUT | | |
|-----------|------------------------|------------------------|------------|------------------------|------|--------|-------|------|-------|-------|------|
| FANAMETEN | | 1521 CONDITI | ONS | | MIN | TYP \$ | MAX | MIN | TYP‡ | MAX | UNIT |
| VIK | V _{CC} = MIN, | $I_1 = -18 \text{ mA}$ | | | | | - 1.5 | | | 1.5 | V |
| VOH | V _{CC} = MIN, | V _{IH} = 2 V, | VIL = MAX, | 1 _{OH} = MAX | 2.4 | 3.4 | | 2.4 | 3.1 | | V |
| VOL | V _{CC} = MIN, | V _{IH} = 2 V, | 1/ - 14AV | IOL = 4 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | V |
| VOL | ACC - MIIA | VIH - 2 V, | VIL = MAX | IOL = 8 mA | | **** | | | 0.25 | 0.5 | |
| loz | VCC = MAX, | V _{IH} = 2 V | | V _O = 2.7 V | | | 20 | | | 20 | |
| 102 | VCC - WAX, | VIH - Z V | | V _O = 0.4 V | | | - 20 | | | 20 | μΑ |
| 11 | V _{CC} = MAX, | V ₁ = 7 V | | | | | 0.1 | | | 0.1 | mΑ |
| liH. | V _{CC} = MAX, | V _I = 2.7 V | | | | | 20 | | | 20 | μΑ |
| 1 | V _{CC} = MAX, | V ₁ = 0.4 V | | Ğ | | | - 0.2 | | | - 0.2 | |
| 115 | VCC - MIAA, | V - 0.4 V | | All other | | | - 0.4 | | | - 0.4 | , mA |
| Ios§ | V _{CC} = MAX | | | | - 30 | | - 130 | - 30 | | - 130 | mA |
| loo | V _{CC} = MAX, | See Note 2 | | Condition A | | 7 | 12 | | 7 | 12 | |
| ¹cc | VCC - WAX, | See Note 2 | | Condition B | | 8.5 | 14 | | 8.5 | 14 | mA |

[†] For conditions shown as MIN or MAX, use the appropriate value spcified under recommended operating conditions.

NOTE 2: I_{CC} is measured with the outputs open under the following conditions:

switching characteristics, V_{CC} = 5 V, T_A = 25°C

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
|------------------|-----------------|-------------|-------------------------------------|------------|-----|-----------------|------|----|
| tPLH . | Data | Y | | | 17 | 25 | | |
| tPHL. | Data | ' | | | 13 | 20 | ns | |
| ^t PLH | Select | | $C_L = 15 pF$, $R_L = 2 k\Omega$, | | 30 | 45 | | |
| tPHL. | Select | ' | | See Note 3 | | 21 | 32 | ns |
| ^t PZH | Output | | | | 15 | 28 | | |
| ^t PZL | Control | ' | | | 15 | 23 | ns | |
| ^t PHZ | Output | | $C_L = 5 pF$, $R_L = 2 k\Omega$, | | 27 | 41 | | |
| ^t PLZ | Control | ' | See Note 3 | | 18 | 27 ⁿ | ns | |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.

[§] Not more than one output should be shorted at a time, and duration for the short-circuit should exceed one second.

A. All inputs grounded.

B. Output control at 4.5 V, all inputs grounded.

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recommended operating conditions

| | | S | N54S2 | 53 | SN74S253 | | | |
|-----|--------------------------------|------|-------|-----|----------|-----|-------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| VIL | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| ЮН | High-level output current | | | -2 | | | - 6.5 | mA |
| IOL | Low-level output current | | | 20 | | | 20 | mA |
| TA | Operating free-air temperature | - 55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | | TEST CONDIT | rions† | | MIN | TYP‡ | MAX | UNIT |
|----------------|------------------------|--------------------------|--------------------------|-------------|------------------------|------|------|--------|------|
| VIK | VCC = MIN, | I ₁ = - 18 mA | | | | | | - 1.2 | V |
| Vон | VCC = MIN, | V _{1H} = 2 V, | V _{1L} = 0.8 V, | IOH = MAX | Series 54S | 2,5 | 3.4 | | V |
| * OH | VCC - WITH, | VIH - 2 V, | VIL - 0.8 V, | IOH = MAX | Series 74S | 2.7 | 3.4 | | V |
| VOL | VCC = MIN, | VIH = 2 V, | VIL = 0.8 V, | IOL = 20 mA | | | | 0.5 | V |
| loz | Vcc = MAX, | VIH = 2 V | | | V _O = 2.4 V | | | 50 | |
| | VCC - WAX, | VIH - Z V | | | V _O = 0.5 V | | | - 50 | μА |
| 1 ₁ | V _{CC} = MAX, | V1 = 5.5 V | | | | | | 1 | mA |
| IН | V _{CC} = MAX, | V _I = 2.7 V | | | | | | 50 | μΑ |
| 111 | V00 - 110 V | V: - 0.5 V | | | G = 0.8 V | | | - 2 | |
| •11. | VCC = MAX, | $V_I = 0.5 V$ | | | G = 2 V | | | - 0.25 | mA |
| los§ | V _{CC} = MAX | | | | 1 | - 40 | | - 100 | mA |
| ¹cc | V _{CC} = MAX, | See Note 2 | | | Condition A | | 45 | 70 | |
| | TOG = WAX, | See Note 2 | | | Condition B | | 65 | 85 | mA |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.

NOTE 2: ICC is measured with the outputs open under the following conditions:

- A. All inputs grounded.
- B. Output control at 4.5 V, all inputs grounded.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CON | MIN TYP | MAX | UNIT | |
|------------------|-----------------|----------------|---|------------------------|------|------|----|
| ^t PLH | Data | ~ | | | 6 | 9 | |
| ^t PHL | Data | 1 | | | 6 | 9 | ns |
| ^t PLH | Select | · · | R _L = 280 Ω, See Note 3 | C _L = 15 pF | 11.5 | 18 | |
| ^t PHL |] 00.001 | ' | | o_ ,o p. | 12 | 18 | ns |
| ^t PZH | Output | · · | *************************************** | | 11 | 16.5 | |
| ^t PZL | Control | | | | 12 | 18 | ns |
| ^t PHZ | Output | V | R _L = 280 Ω, | C _L = 5 pF | 6.5 | 9.5 | |
| ^t PLZ | Control | 1 | See Note 3 | | 10 | 15 | ns |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.



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PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|-------------------------------|---------|
| 76017012A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 76017012A SNJ54LS 253FK | Samples |
| 7601701EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7601701EA SNJ54LS253J | Samples |
| 7601701EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7601701EA SNJ54LS253J | Samples |
| JM38510/30908BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30908BEA | Samples |
| JM38510/30908BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30908BEA | Samples |
| JM38510/30908BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30908BFA | Samples |
| JM38510/30908BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30908BFA | Samples |
| M38510/30908BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30908BEA | Samples |
| M38510/30908BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30908BEA | Samples |
| M38510/30908BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30908BFA | Samples |
| M38510/30908BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30908BFA | Samples |
| SN54LS253J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS253J | Samples |
| SN54LS253J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS253J | Samples |
| SN74LS253DR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS253 | Samples |
| SN74LS253DR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS253 | Samples |
| SN74LS253N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS253N | Samples |
| SN74LS253N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS253N | Samples |

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| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|-------------------------------|---------|
| SNJ54LS253FK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 76017012A SNJ54LS 253FK | Samples |
| SNJ54LS253FK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 76017012A SNJ54LS 253FK | Samples |
| SNJ54LS253J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7601701EA SNJ54LS253J | Samples |
| SNJ54LS253J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7601701EA SNJ54LS253J | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF SN54LS253, SN74LS253:

■ Catalog : SN74LS253

Military: SN54LS253

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LS253DR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS253DR | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 |

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

| The difference are floring. | | | | | | | | | | |
|-----------------------------|--------------|--------------|------|-----|--------|--------|--------|--------|--|--|
| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) | | |
| 76017012A | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA | | |
| SN74LS253N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 | | |
| SN74LS253N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 | | |
| SNJ54LS253FK | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA | | |

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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